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Accurate Modeling of Multilayer Transmission Lines for High-Speed Digital Interconnects

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Abstract

In this paper, we consider the finite element modeling of multilayer transmission lines for high-speed digital interconnects. We mainly focused on the modeling of the transmission structures with both cases of symmetric and asymmetric geometries. We specifically designed asymmetric coupled microstrips and four-line symmetric coupled microstrips with a two-layer substrate. We computed the capacitance matrix for asymmetric coupled microstrips on a two-layer substrate. We also provide the potential distribution spectrums of the models.

Keywords: Capacitance matrix, inductance matrix, multilayer, multicondcutor transmission lines, finite element method

I. Introduction

Recently, the development of efficient and accurate computational method to analyze the modeling of multiconductor transmission lines in multilayer structure becomes a great area of interest. An accurate analysis of pulse propagation in multiconductor transmission line and coupled microstrips turns out to be important in high speed and high density digital interconnects due to the clock rates increase and interline spacings decrease. Also, lumped element approximations of high speed VLSI interconnects are currently sufficient for the design processes; the next generation of computers will need an accurate, field theory analysis that includes the effects of coupling, dispersion, and losses. Therefore, researches require for fast and accurate analysis of multilayer, multiconductor, and high speed interconnects.

Previous attempts at the problem include using the method of moments [1, 2], the spectral domain approach [3, 4], the Green's function approach [3, 5], the method of lines [6, 7], the domain decomposition method and finite difference methods [7], the integrated equation

method [8], and the complex image method [9]. Also, the pulse distortion on symmetric, coupled, lossy microstrips is discussed in [10].

In this work, we design asymmetric coupled microstrips and four-line symmetric coupled microstrips with a two-layer substrates using finite element method (FEM). We specifically calculate the capacitance and inductance matrices, and the potential distribution of the configurations.

II. Results and Discussions

The models have solution regions that are unbounded (or open). meaning that the electromagnetic fields should extend towards infinity. This is not possible because it would require a very large mesh. The easiest approach is just to extend the simulation domain "far enough" that the influence of the terminating boundary conditions at the far end becomes negligible. In any electromagnetic field analysis, the placement of far-field boundary is an important concern, especially when dealing with the finite element analysis of structures which are open. It is necessary to take into account the natural boundary of a line at infinity and the presence of remote objects and their potential influence on the field shape [11]. In all our simulations, the open multiconductor structure is surrounded by a W X H shield, where W is the width and H is the thickness.

The models are designed using electrostatic environment in order to compare our results with the other available methods. In the boundary condition of the model's design, we use ground boundary which is zero potential (V=0) for the shield. We use port condition for the conductors to force the potential or current to one or zero depending on the setting. Also, we use continuity boundary condition between the conductors and between the conductors and left and right grounds. The quasi-static models are computed in form of electromagnetic simulations using partial differential equations.

In this paper, we consider two different models. Asymmetric coupled microstrips and fourline symmetric coupled microstrips with two-layer substrates.

2.1 Modeling of Asymmetric Coupled Microstrips on a Two-Layer Substrate

In Fig. 1, we show the cross-section of asymmetric coupled microstrips on a two-layer substrate with the following parameters:

 $w_1 =$ width of strip 1 = 0.6 mm

 $w_2 = \text{width of strip } 2 = 1.2 \text{ mm}$

- s = distance between the strip 1 and strip 2 = 0.3 mm
- t = thickness of the strips = 0.01mm
- h_1 = height of the first layer from the ground

- h_2 = height of the strips from the first layer
 - = 0.3 mm



Figure 1. Cross-section of asymmetric coupled microstrips on a two-layer substrate.

For the modeling, the geometry was enclosed by a 10 X 3 mm shield. Figure 2 shows the finite element mesh which consists of 3273 elements with number of degrees of freedom solved for 36762 in a solution time 6.719 seconds. Figure 3 shows the 2D surface potential distribution of the transmission lines. Contour and streamline plots were presented in Figures 4 and 5 respectively.



Figure 2. Mesh of asymmetric coupled microstrips on a two-layer substrate.



Figure 3. 2D surface potential distribution of asymmetric coupled microstrips on a two-layer substrate.



Figure 4. Contour plot of asymmetric coupled microstrips on a two-layer substrate.



Figure 5. Streamline plot of asymmetric coupled microstrips on a two-layer substrate.

From our model, Figure 6 shows the potential distribution of the five-conductor transmission lines from (x,y) = (0,0) to (x,y) = (10,3) mm, using port 1 as input.



Figure 6. Potential distribution of asymmetric coupled microstrips on a two-layer substrate from (x,y) = (0,0) to (x,y) = (10,3) mm, using port 1 as input.

The following electrical parameters, capacitance per unit length matrix ($\begin{bmatrix} C \end{bmatrix}$ in pF/m) and inductance per unit length ($\begin{bmatrix} L \end{bmatrix}$ nH/m) are found as:

$$\begin{bmatrix} C \end{bmatrix} = \begin{bmatrix} 115.182 & -45.004 \\ -45.004 & 148.036 \end{bmatrix}$$

The inductance and capacitance per unit length of multiconductor transmission lines are related as follows:

$$\begin{bmatrix} L \end{bmatrix} = \mu_o \mathcal{E}_o \begin{bmatrix} C_o \end{bmatrix}^{-1}, \tag{1}$$
 where,

[L] = Inductance matrix.

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 $\left[C_o\right]^{-1}$ = the inverse matrix of the capacitance of the multiconductor transmission line when all dielectric constants are set equal to 1.

 μ_{o} = permeability of free space or vacuum.

 \mathcal{E}_o = permittivity of free space or vacuum.

$$[L] = \begin{bmatrix} 395.2 & 82.6 \\ 82.6 & 284.2 \end{bmatrix}$$

2.2 Modeling of Four-Line Symmetric Coupled Microstrips with a Two-Layer Substrates

In this section, we illustrate the modeling of the four-line symmetric coupled microstrips with two-layer substrates. We focus on the calculation of capacitance per unit length, the capacitance with homogenous dielectric layer, inductance. In Fig. 7, we show the cross-section of four-line symmetric coupled microstrips with two-layer substrates with the following parameters:

w = width of strips = 0.5 mm

s = distance between two strips = 0.5 mm

t = thickness of the strips = 0.01mm

- h_1 = height of the first layer from the ground = 0.335 mm
- h_2 = height of the strips from the first layer

= 0.3 mm



Figure 7. Cross-section of four-line symmetric coupled microstrips with two-layer substrates.

For the modeling, the geometry was enclosed by a 30 X 3 mm shield. Figure 8 shows the finite element mesh which consists of 6650 elements with number of degrees of freedom solved for 27539 in a solution time 4.843 seconds. Figure 9 shows the 2D surface potential distribution of the transmission lines. Counter and streamline plots were presented in Figures 10 and 11 respectively.



Figure 8. Mesh of four-line symmetric coupled microstrips with two-layer substrates.



Figure 9. 2D surface potential distribution of fourline symmetric coupled microstrips with two-layer substrates.



Figure 10. Contour plot of four-line symmetric coupled microstrips with two-layer substrates.



Figure 11. Streamline plot of four-line symmetric coupled microstrips with two-layer substrates.

From our model, Figure 12 shows the potential distribution of the five-conductor transmission lines from (x,y) = (0,0) to (x,y) = (30,3) mm, using port 1 as input.



Figure 12. Potential distribution of our-line symmetric coupled microstrips with two-layer substrates from (x,y) = (0,0) to (x,y) = (30,3)mm, using port 1 as input.

The following electrical parameters (capacitance per unit length matrix ($\begin{bmatrix} C \end{bmatrix}$ in pF/m), inductance per unit length ($\begin{bmatrix} L \end{bmatrix}$ in nH/m), and

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characteristic impedances matrix ([Z] in Ω) are found as

<i>C</i> =	99.53343	-29.54885	-0.9212119	-0.1340122
	-29.54885	109.6809	-29.25836	-0.9206155
	-0.9212119	-29.25836	109.7019	-29.56089
	-0.1340122	-0.9206155	-29.56089	99.53665

Using equation 1, we obtain [L]:

[<i>L</i>]=	440.1480	89.4267	26.0729	8.7115
	89.2120	437.0070	88.7116	26.0747
	25.2873	88.5647	436.984334	89.4334
	4.8237	25.2891	89.2186	440.1612

We provided the results of FEM in twodimensional asymmetric coupled microstrips and four-line symmetric coupled microstrips with a twolayer substrates. The results of capacitance matrices for self and mutual capacitances and inductance matrix which are useful for the analysis of crosstalk between high-speed signal traces on the printed circuit board are obtained.

III. Conclusions

In this paper we have presented the modeling of asymmetric coupled microstrips and four-line symmetric coupled microstrips with twolayer substrates using FEM. We have obtained the results for their electrical parameters such as the capacitance-per-unit length and we provided the potential distribution spectrums of the models.

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